



SUA-110P13Cx-x-S236

SHELL :

Blank : BRASS

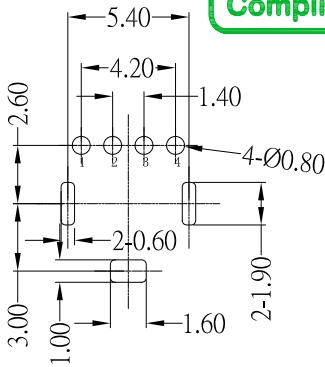
I : SPCC

鍍層厚度 :

Blank : 1u"

2 : 15u"

3 : 30u"



PCB LAYOUT

SPECIFICATIONS

Electrical:

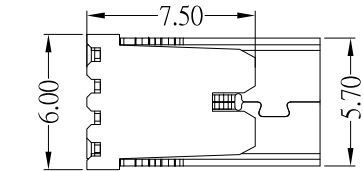
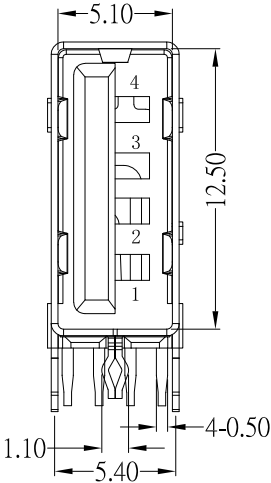
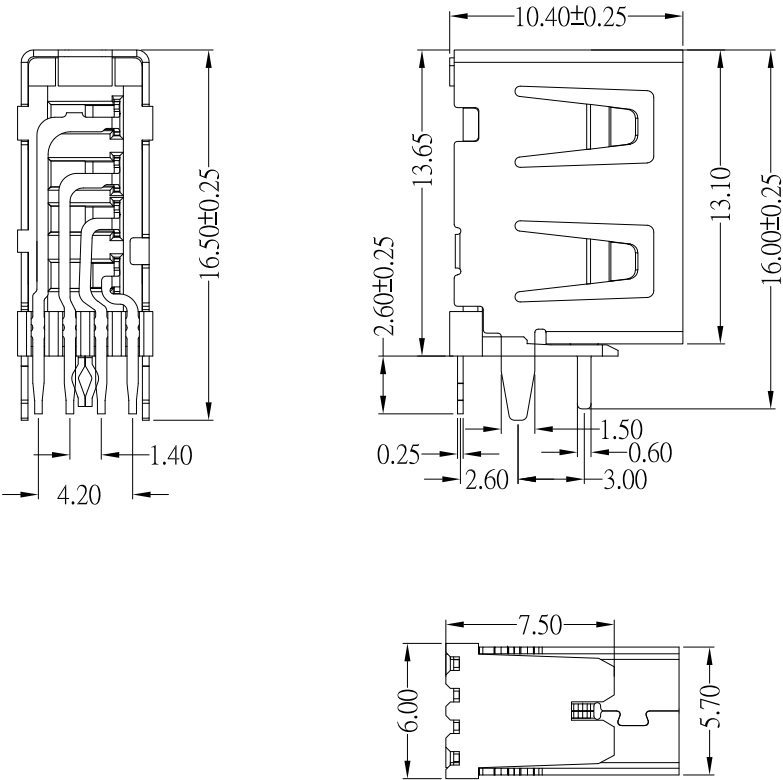
- 1.Current: 30V DC , 1.5A
- 2.Dielectric Withstanding Voltage: AC 500V
- 3.Insulation Resistance: 1000 MΩ Min
- 4.Contact Resistance: 30 mΩ Max

Material:

- 1.Housing: PBT
- 2.Contact: Brass
- 3.Shell: Brass / Spcc

Finish:

- 1.Contact: Plated Gold in Mating Area ;
Tin Plated on Solder Balls ;
Nickel under plated overall
- 2.Shell: Nickel under Plated surface layer



CONTACT 建倚科技股份有限公司
CONTACT TECHNOLOGY CORP.

TOLERANCE UNLESS OTHERWISE STATED :
Up to 5 ±0.2
Above 5 ~ 15 ±0.3
Above 15 ~ 30 ±0.4
Above 30 ~ 50 ±0.5
Angle ±0.3°
3RD. ANGEL'S
UNITS MM

DRAWN BY:	DATE	MAT'L		TITLE	CONNECTOR
Jack Lu	11/08/24	FINISH		MODLE	USB AF 側插短體無捲邊 L=10.40mm
CHECKED BY:	DATE	SCALE	1 : 1	DWG NO.	SUA-110P13Cx-x-S236
Jacky Chen	11/08/24	SHEET NO.	1 of 1	PART NO.	SUA-110P13Cx-x-S236
APPROVED BY:	DATE				
Tony Kao	11/08/24				